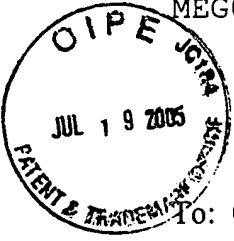


IFW

MEG03-005

appl. no. 10/796,427

July 15, 2005



To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/796,427 03/09/04

MOU-SHIUNG LIN

"POST-PASSIVATION METAL SCHEME ON AN IC  
CHIP WITH COPPER INTERCONNECTION"

Grp. Art Unit: 2822 LEWIS, MONICA

RESPONSE TO RESTRICTION REQUIREMENT AND PRELIMINARY AMENDMENT

Dear Sir:

In response to the Restriction Requirement mailed June 30, 2005, please amend the  
above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal  
Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box  
1450, Alexandria, VA 22313-1450, on July 15, 2005.

Stephen B. Ackerman, Reg. No. 37,761

Signature SSD  
Date July 15, 2005

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of the Claims which begins on page 5 of this paper.

Remarks/Arguments begin on page 8 of this paper.